

Wire to Board Connectors, Pitch 4.2mm series

1. Scope

This specification covers the Wire to Board pitch 4.2mm series connectors.

2. Applicable documents

The following documents form a part of this specification to the extent specified herewith. In the event of conflict between the requirements of the specification and the product drawing, the product drawing shall take precedence.

In the event of conflict between the requirements of the specification and the referenced documents, this specification shall take precedence.

3. Ordering information

Refer to the drawing.

4. Connector dimensions

Refer to the drawing.

5. Material

Housing: PA66 (UL 94V-0/UL 94V-2)

Color:Transparent

Contacts terminal: Copper alloy

Plating:Tin plated

6. Accommodated P.C.B layout

Refer to the drawing.

7. Rating

Operating voltage(Max.) 250V AC/DC Current rating(Max.) 9.0A DC

Temperature range-operating -40°C -- +105°C(Including terminal temperature rese)

8. Performance

Test item	Requirement	Test Condition					
Appearance	Plastic part:smooth and flat surface without discolor,broken,crack,distortion defects is acceptable Metal part:bright and even surface without rust,oxide,fog and obvious physical damage defects is acceptable	Visual by eye Light: > 1.0 Lamp: (200~300)lx Space:(0.3~0.5)m					
Electrical Performance							
Contact Resistance	10 mΩ (Max.)	Mate connectors, measure by dry circuit, 20mV MAX., 10mA. Mated Length: 50mm (Based upon JIS C5402 5.4)					

STANDARD SPECIFICATION

RVA.



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Test item	Requirement				Test Condition
Insulation Resistance	1000 MΩ (Min.)			Mate connectors, apply 500V DC between adjacent terminals or ground. (Based upon JIS C5402 5.2/MIL-STD-202 method 302 cond.B)	
Withstand voltage	No breakdown and flashover				Mate connectors, apply 1500V AC for 1 minute between adjacent terminal or ground. (Based upon JIS C5402 5.1/MIL-STD -202 Method301)
Contact resistance on crimped portion	10 mΩ (Max.)				Crimp the maximum applicable wire on to the terminal, measure by dry circuit, 20mV MAX., 10mA. Wire Length: 50mm
Mechanical Performance					
Insertion and Withdrawal Force	unsemon force		1.5kgf circuit	(Max.) per	Insertion and withdrawal connectors at the speed rate of
	Withdrawal for	ndrawal force 0.05kgf (Min.) per circuit			1mm/s~5mm/s
Terminal/Housing Retention Force	2.0kgf (Min.)				Apply axial pull out force at a speed of 25±3mm/minute on the terminal assembled In the housing.
	AWG#16	WG#16 AWG#18 AWG#20			
	9.0Kgf(Min.) 9.0Kgf		f(Min.)	6.0Kgf(Min.)	Firstly and the second of the
Crimping pull Out Force	AWG#22 AWG			AWG#26	Fix the crimped terminal, apply axial pull out force on the wire at a speed of 25±3mm/minute
, 2 h				1.9Kgf(Min.)	(Based upon JIS C5402 6.22)
	AWG#28 1.0Kgf(Min.)				
Pin retentive Force	1.0kgf (Min.)				Apply axial push force at a speed of 25±3mm/minute on the contact pin assembled in the base wafer
		En	vironn	nental Perforr	mance and others
Heat resistance	Appearance No Damag		mage	Mated connector shall be placed in an oven for 96±4 hours at +105±2°C. (Based upon JIS C5402 7.8)	
	Contact Resistance 20 mΩ Max.		Max.		
Cold resistance	Appearance N		No Damage		Mated connector shall be placed in a temperature chamber for 96±4 hours at -40±3°C
	Contact Resistance 20 n		20 mΩ	Max.	(Based upon JIS C5402 7.9)
Repeated Insertion/ withdrawal	Contact Resistance 20 mΩ Max.		Max.	Mate connector up to 30 cycles repeatedly at a rate of 10 cycles/ minute. After which test the contact resistance	

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Test item	Requirement		Test Condition
Humidity	Appearance	No Damage	
	Contact Resistance	Mated connector shall be placed in a humidity cham the following conditions.	
	Withstand voltage	1500 V AC/min	Temperature: 40±2°C Relative humidity: 90~95% Duration: 96 Hours
	Insulation Resistance	1000 MΩ Min.	(Based upon MIL-STD-202 Method 103 condition A)
Temperature Cycling	Appearance	No Damage	Mated connector shall be set to temperature cycling for 5 cycles of which 1 cycle consists of: 1>40°C ~ 30 minutes
	Contact Resistance	20 mΩ Max.	2>.+105°C ~ 30 minutes (Based upon JIS C0025)
Temperature Rise	30 ℃ Max.		Apply rated current load on mated connector in series- connection. Measure change of temperature on contact using thermocouples for 4 hours. (Based upon UL 1977)
Vibration	Appearance	No Damage	Amplitude:±0.35mm Frequency:10~55Hz Frequency:(55~500)Hz Acceleration:50m/s2
	Contact Resistance	20 mΩ Max.	
	Discontinuity	1μ sec Max.	Duration:2h in each X.Y.Z axes
	Appearance	No Damage	
Shock	Contact Resistance	20 mΩ Max.	50G, 3 strokes in each X.Y.Z axes (Based upon JIS C0041)
	Discontinuity	1μ sec Max.	
Salt Spray	Appearance	No Damage	Mated connector shall be placed in a salt spray chamber on the following conditions. Salt Solution Density: 5±1%
	Contact Resistance	20 mΩ Max.	Temperature: 35±2°C Duration: First punch,second plate:24±4Hours First plate,second punch:8±2Hours Remarks: we make sure the important area
Solderability	95% of immersed area must show no voids nor pin holes		Immerse fluxed soldered section of contact pin into a solder bath for 3±0.5sec, temperature: 230±5°C
Resistance to soldering heat	Appearance	No Damage	Soldering Time: 5±1sec heat Soldering Temperature: 260±5 ℃